

| | |
|---|----------------|
|  | E502650 |
|---|----------------|

Features

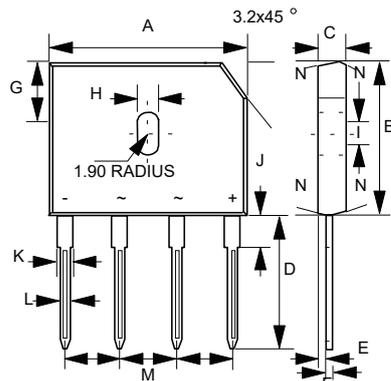
- Halogen Free. "Green" Device (Note 1)
- Planar Chip Junction
- Low Forward Voltage Drop
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant (Note 2)("P" Suffix Designates RoHS Compliant. See Ordering Information)

**15 Amp
Low VF Bridge
Rectifiers
600 Volts**

Maximum Ratings @ 25°C (Unless Otherwise Specified)

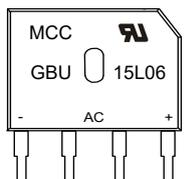
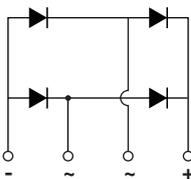
| Parameter | Symbol | Value | Unit |
|---|-------------|-------|----------------------|
| Peak Repetitive Reverse Voltage | V_{RRM} | 600 | V |
| Working Peak Reverse Voltage | V_{RWM} | | |
| DC Blocking Voltage | V_R | | |
| RMS Reverse Voltage | V_{RMS} | 420 | V |
| Average Rectified Forward Current @ $T_C=110^\circ\text{C}$ (With Heatsink) | $I_{F(AV)}$ | 15 | A |
| Average Rectified Forward Current @ $T_A=25^\circ\text{C}$ (Without Heatsink) | | 3.5 | |
| Non-Repetitive Peak Surge Current @ 8.3ms Half Sine Wave | I_{FSM} | 250 | A |
| Non-Repetitive Peak Surge Current @ 1ms Square Wave | | 500 | |
| I^2t Rating for Fusing @ $1\text{ms} \leq t \leq 8.3\text{ms}$ | I^2t | 259 | A^2s |
| Dielectric strength @ Terminals to Case, AC 1 Minute | V_{dis} | 2.5 | KV |

GBU



| DIMENSIONS | | | | | |
|------------|--------------|-------|-------|-------|------|
| DIM | INCHES | | MM | | NOTE |
| | MIN | MAX | MIN | MAX | |
| A | 0.860 | 0.880 | 21.80 | 22.30 | |
| B | 0.720 | 0.740 | 18.30 | 18.80 | |
| C | 0.130 | 0.142 | 3.30 | 3.60 | |
| D | 0.690 | 0.717 | 17.50 | 18.20 | |
| E | 0.030 | 0.039 | 0.76 | 1.00 | |
| F | 0.018 | 0.024 | 0.46 | 0.60 | |
| G | 0.290 | 0.310 | 7.40 | 7.90 | |
| H | 0.140 | 0.160 | 3.50 | 4.10 | |
| I | 0.065 | 0.085 | 1.65 | 2.16 | |
| J | 0.060 | 0.096 | 1.52 | 2.45 | |
| K | 0.077 | 0.098 | 1.95 | 2.50 | |
| L | 0.040 | 0.050 | 1.02 | 1.27 | |
| M | 0.190 | 0.210 | 4.83 | 5.33 | |
| N | 7.0° TYPICAL | | | | |

Internal Structure

| Simplified Outline | Graphic Symbol |
|---|---|
|  |  |

- Note:
1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 2. High temperature solder exemption applied, see EU directive annex 7a.

Thermal characteristics

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---------------|---|------------------|-----|-----|-----|------|
| T_J | Operating Junction Temperature Range | | -55 | | 150 | °C |
| T_{stg} | Storage Temperature Range | | -55 | | 150 | °C |
| $R_{th(J-C)}$ | Thermal Resistance from Junction to Case | Note 1 | | 1.4 | | °C/W |
| $R_{th(J-A)}$ | Thermal Resistance from Junction to Ambient | Without Heatsink | | 25 | | °C/W |

Note:

1. Device mounted on 75mm x 45mm x 5.5mm Aluminum Plate Heatsink.

Mechanical Data

Recommended Mounting Torque: 5 in-lbs

Electrical Characteristics @ 25°C Unless Otherwise Specified(Per Diode)

| Parameter | Symbol | Test Conditions | Min | Typ | Max | Unit |
|----------------------|--------|---|-----|--------------|--------------|------|
| Forward Voltage | V_F | $I_F=7.5A; T_J=25^\circ C$ $I_F=7.5A; T_J=125^\circ C$ | | 0.86 0.75 | 0.92 0.80 | V |
| Reverse Current | I_R | at Rated $V_R; T_J=25^\circ C$ at Rated $V_R; T_J=125^\circ C$ | | | 5 50 | uA |
| Junction Capacitance | C_J | $V_R=4V; f=1MHz; T_J=25^\circ C$ | | 128 | | pF |

Curve Characteristics

Fig. 1 - Forward Current Derating Curve

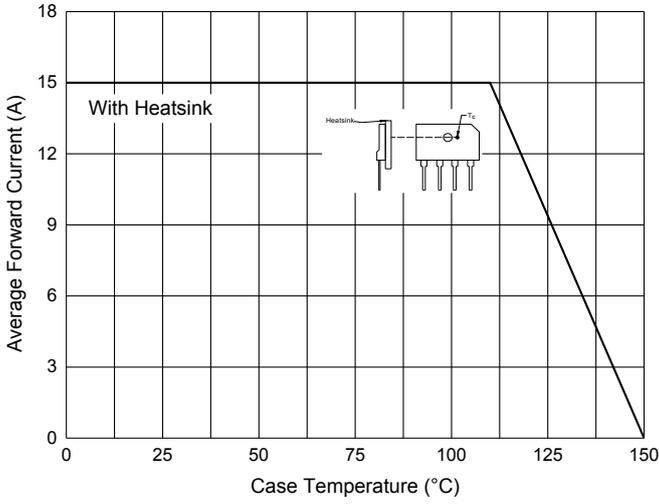


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current (Per Diode)

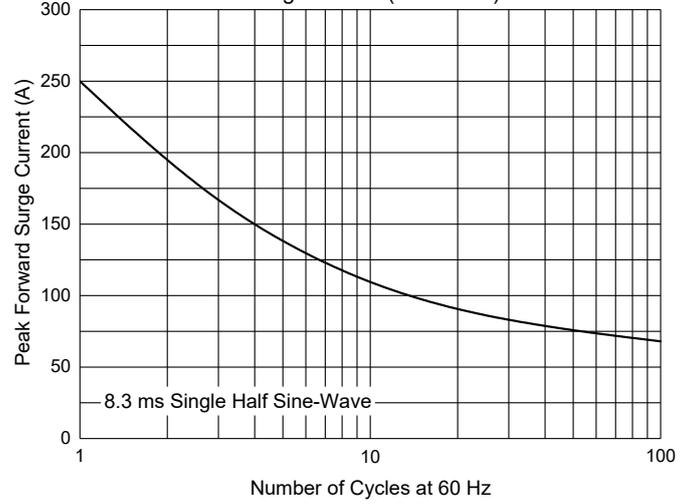


Fig. 3 - Typical Forward Characteristics (Per Diode)

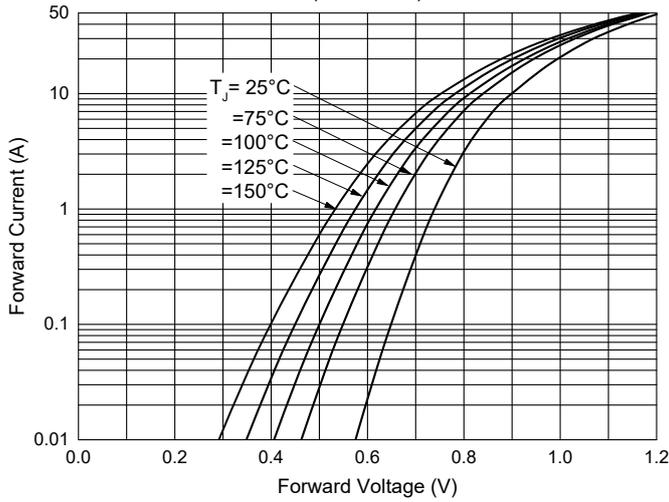


Fig. 4 - Typical Reverse Leakage Characteristics (Per Diode)

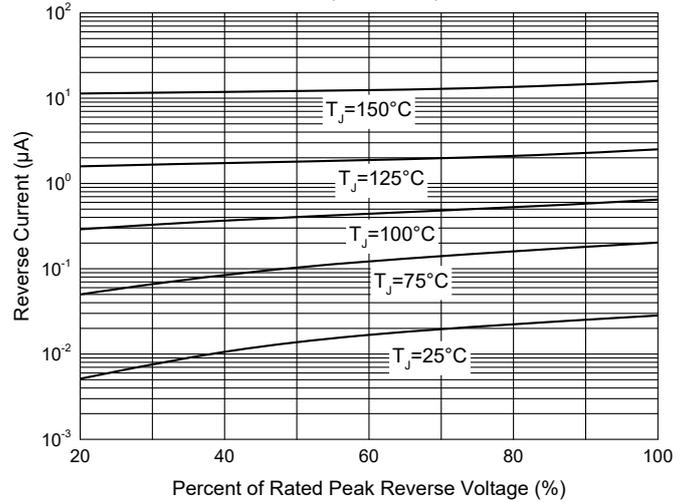
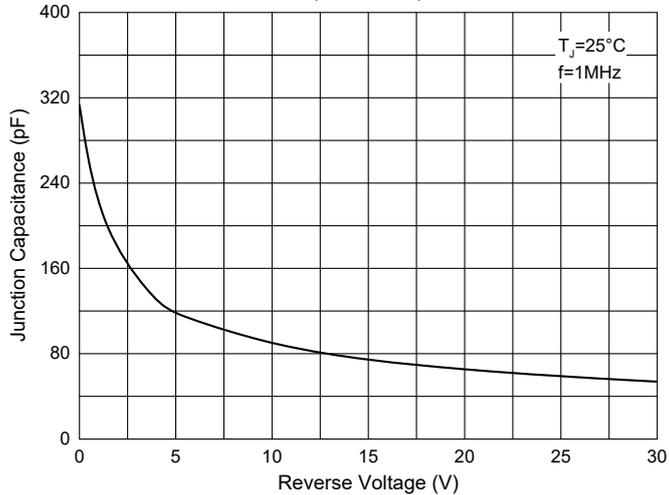


Fig. 5 - Typical Capacitance Characteristics (Per Diode)



Ordering Information

| Device | Packing |
|-------------|--|
| GBU15L06-BP | Bulk:20pcs/Tube,1Kpcs/Box,2Kpcs/Carton |

IMPORTANT NOTICE

Micro Commercial Components Corp. reserves the right to make changes without further notice to any product herein to make corrections, modifications , enhancements , improvements , or other changes . **Micro Commercial Components Corp** . does not assume any liability arising out of the application or use of any product described herein; neither does it convey any license under its patent rights ,nor the rights of others . The user of products in such applications shall assume all risks of such use and will agree to hold **Micro Commercial Components Corp** . and all the companies whose products are represented on our website, harmless against all damages. **Micro Commercial Components Corp.** products are sold subject to the general terms and conditions of commercial sale, as published at <https://www.mccsemi.com/Home/TermsAndConditions>.

LIFE SUPPORT

MCC's products are not authorized for use as critical components in life support devices or systems without the express written approval of Micro Commercial Components Corporation.

CUSTOMER AWARENESS

Counterfeiting of semiconductor parts is a growing problem in the industry. Micro Commercial Components (MCC) is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. MCC strongly encourages customers to purchase MCC parts either directly from MCC or from Authorized MCC Distributors who are listed by country on our web page cited below. Products customers buy either from MCC directly or from Authorized MCC Distributors are genuine parts, have full traceability, meet MCC's quality standards for handling and storage. **MCC will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources.** MCC is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.